

Fig. 1

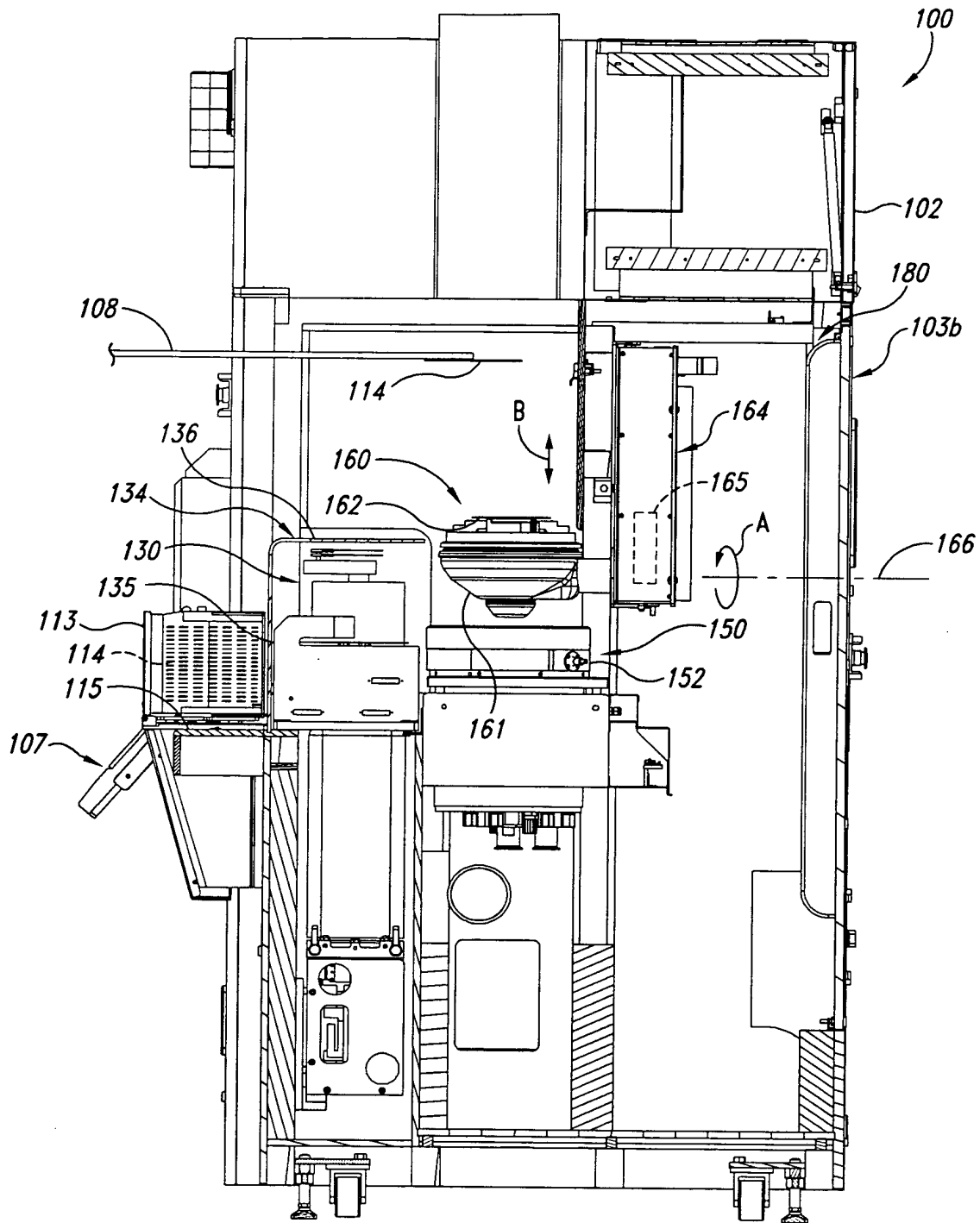
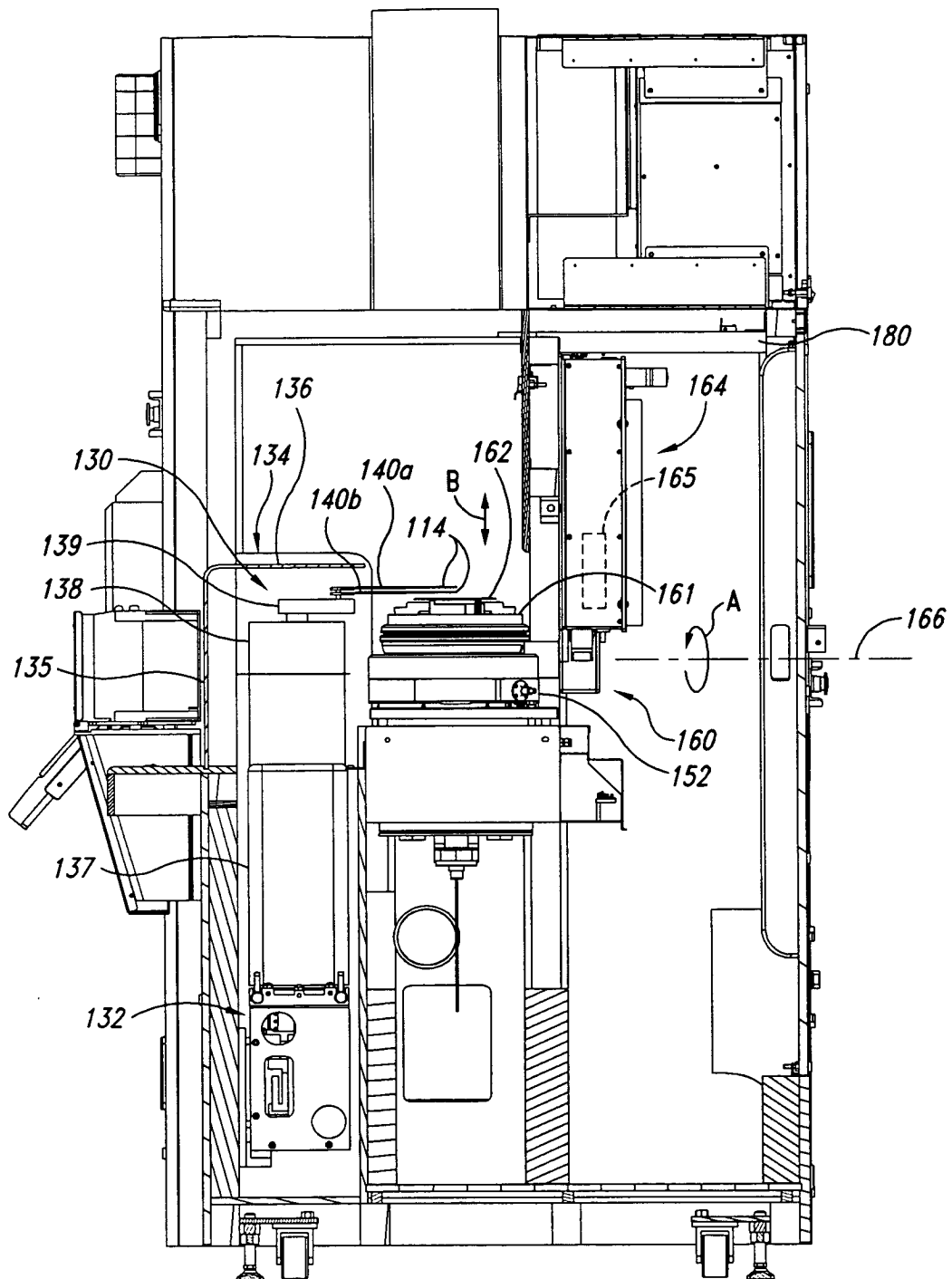


Fig. 2

*Fig. 3*

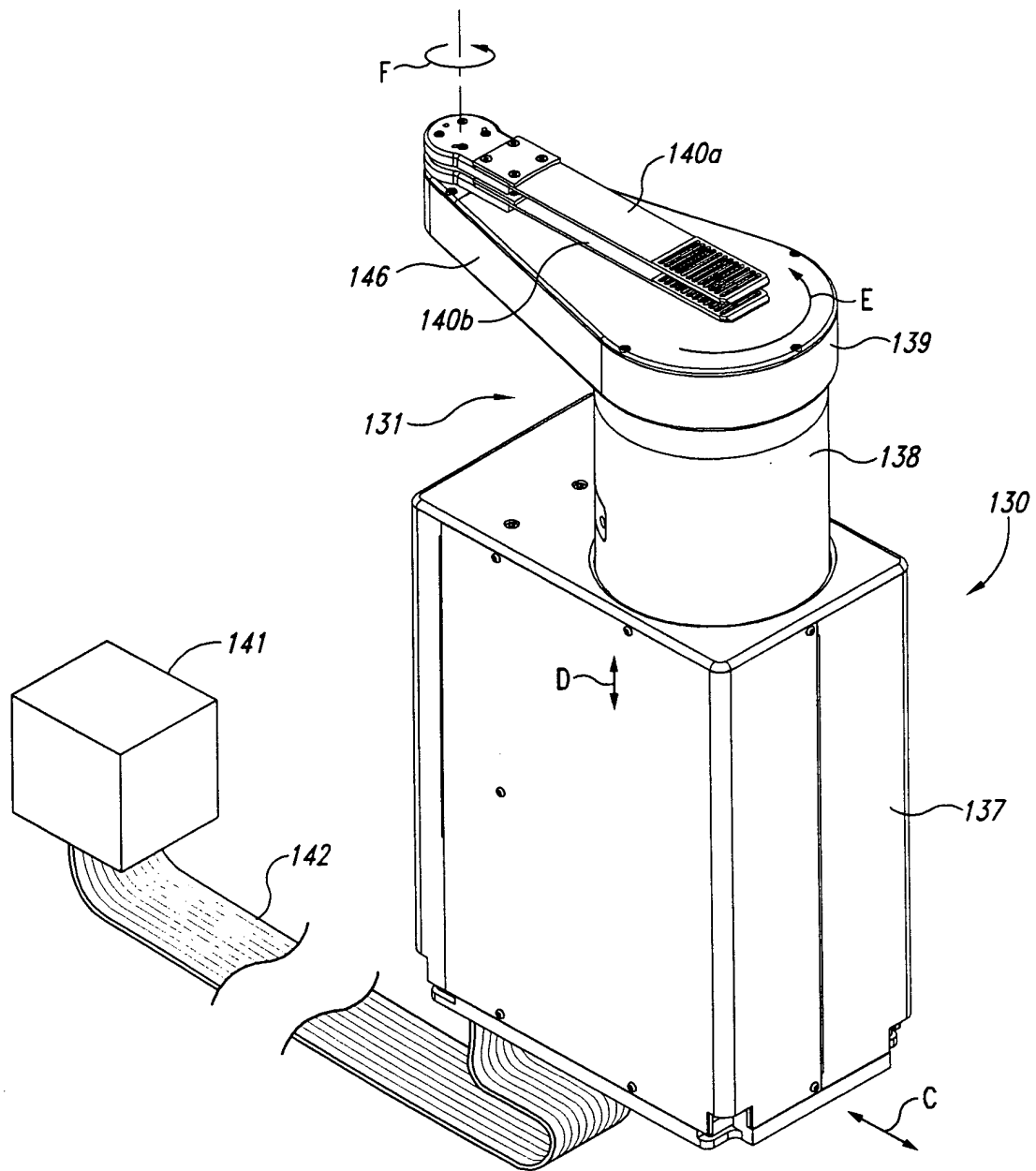


Fig. 4

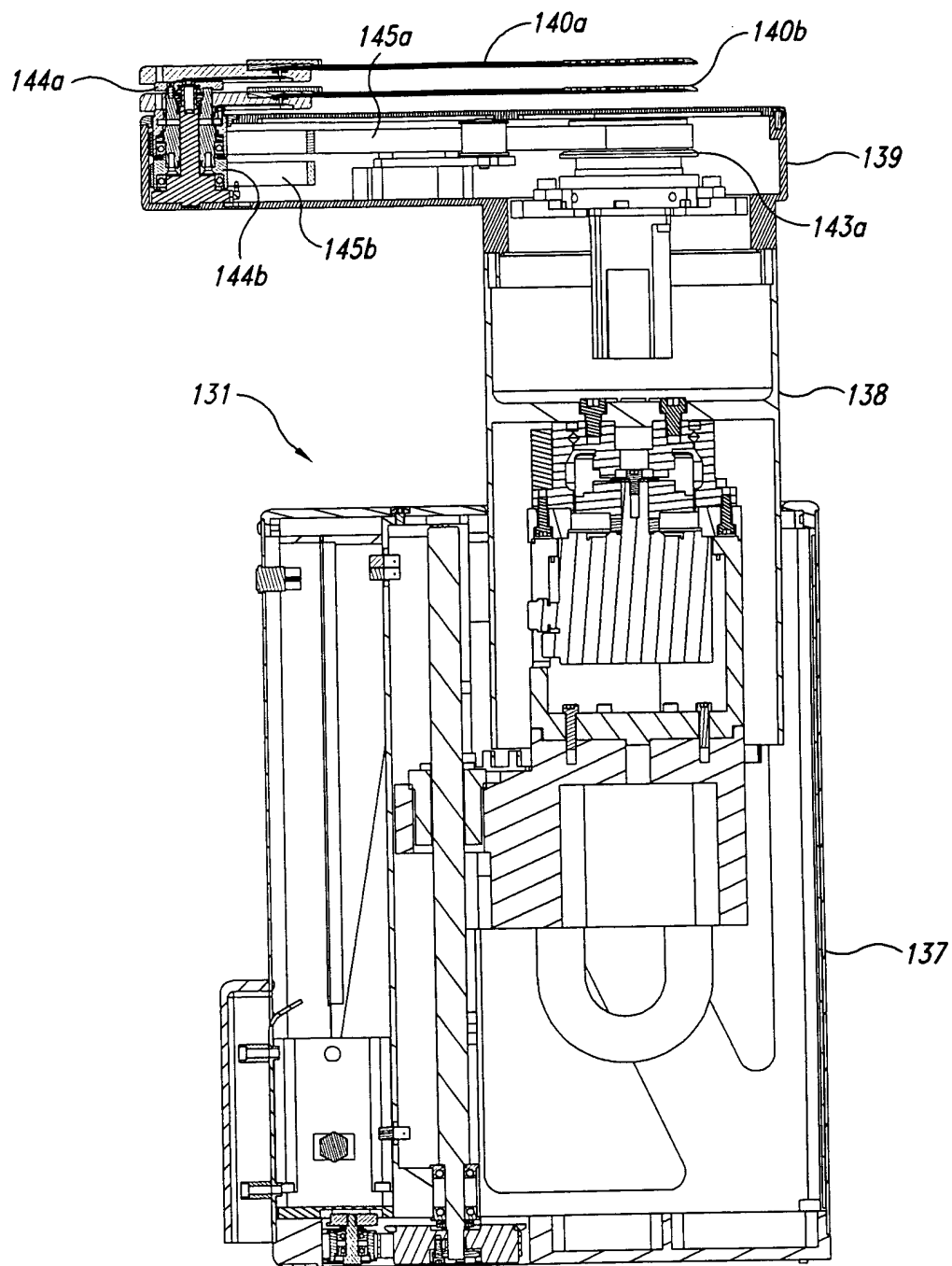
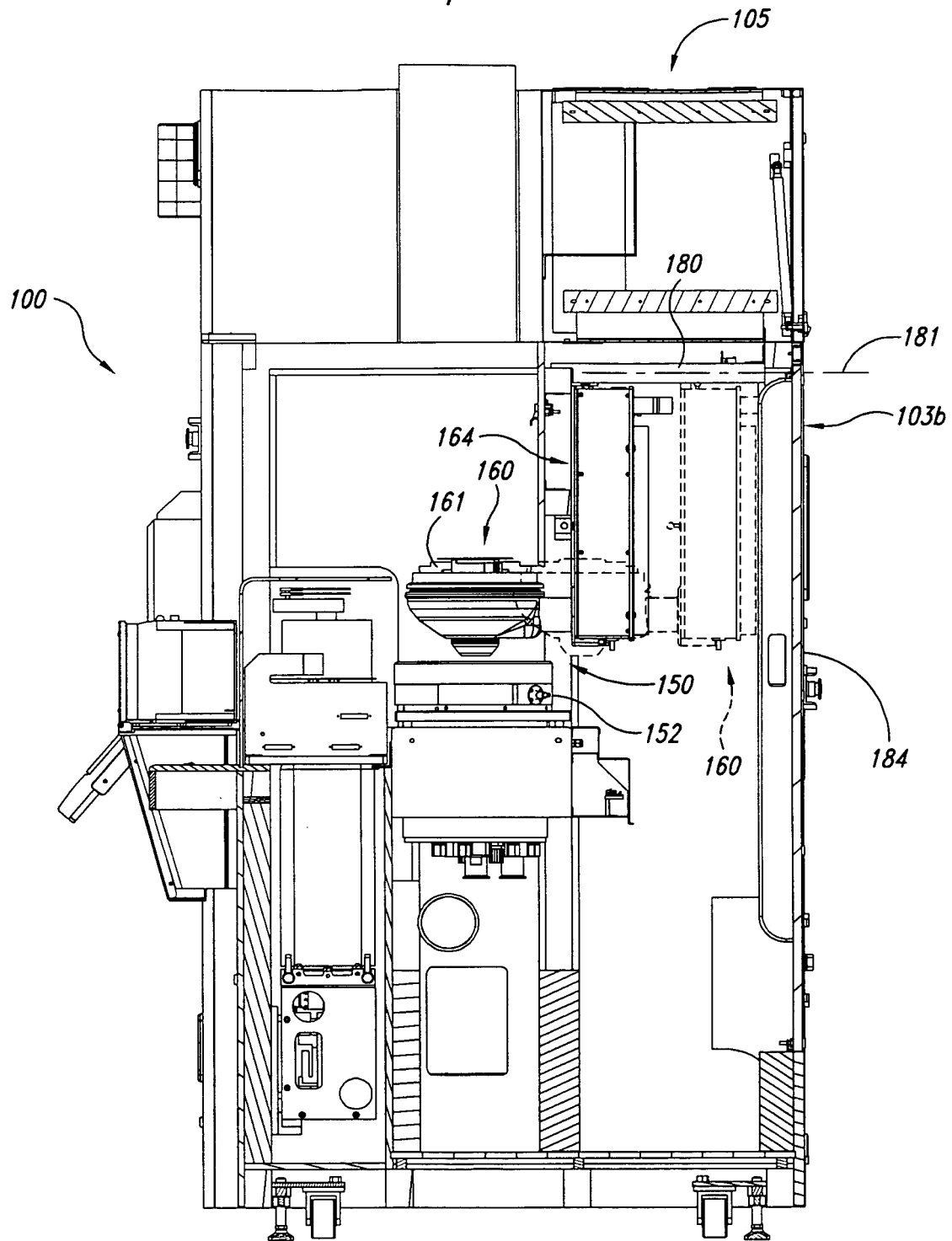
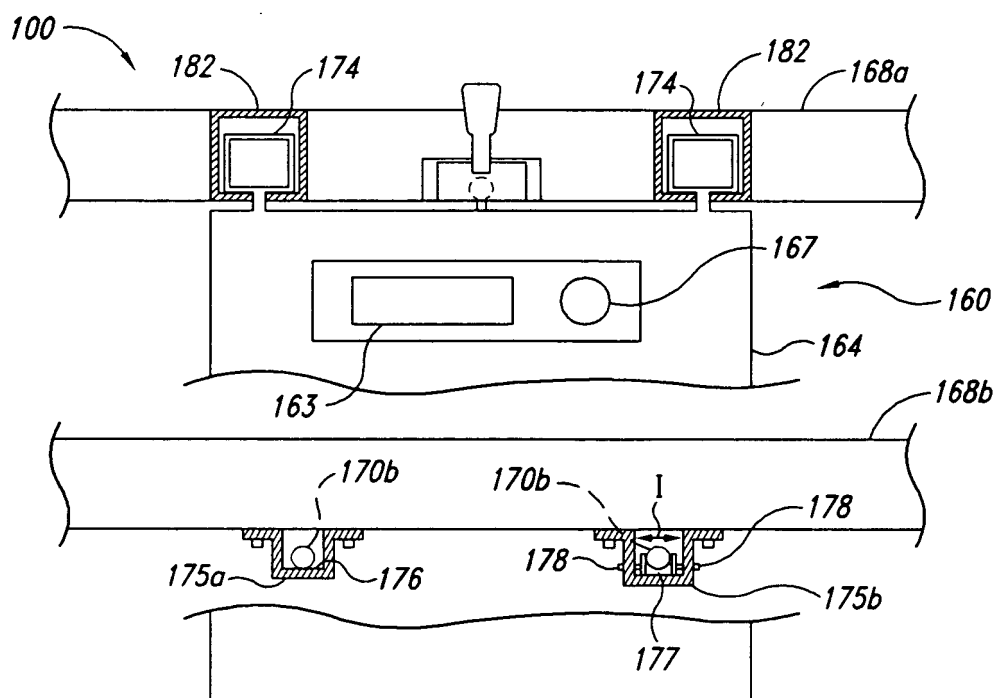
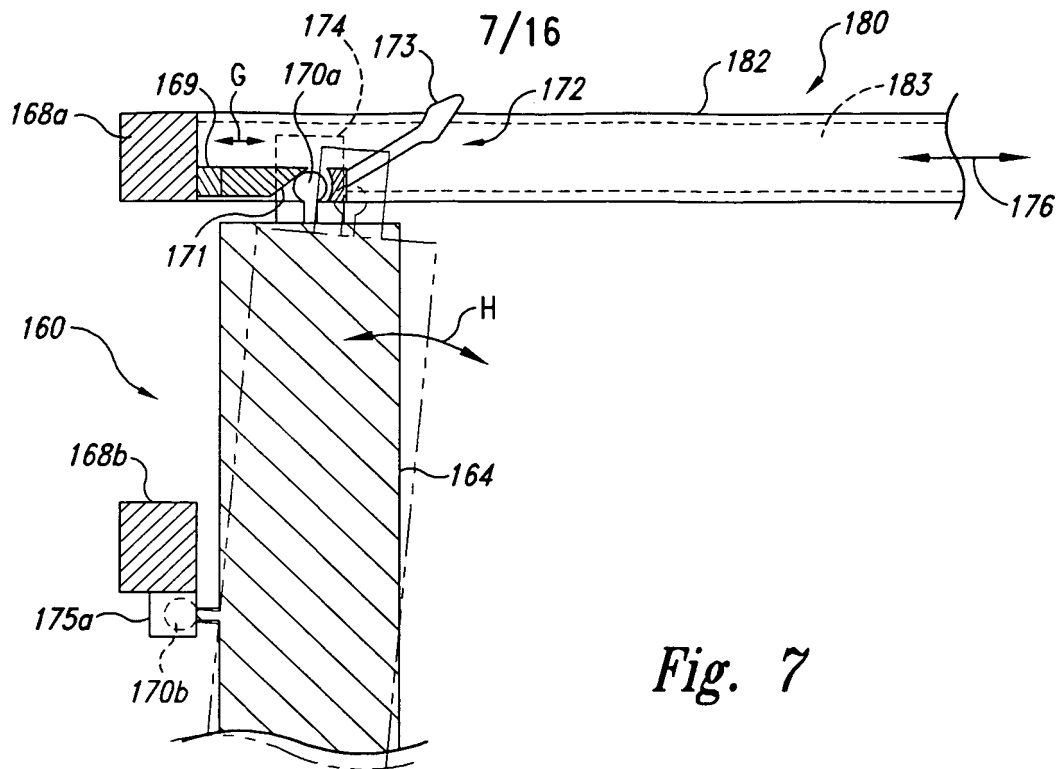
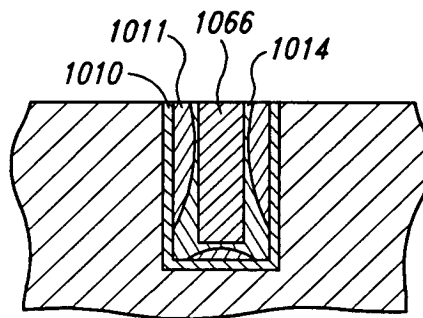
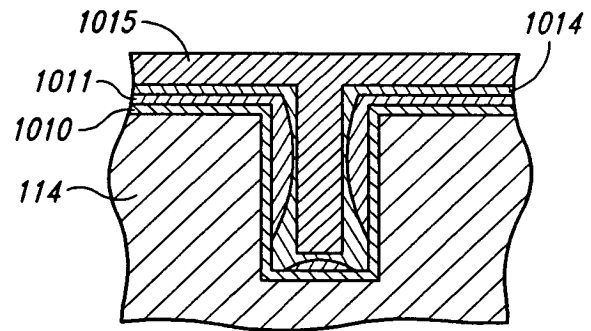
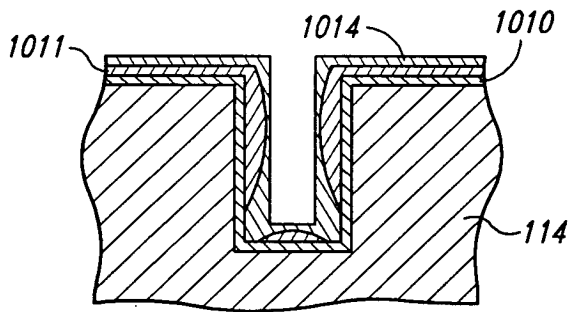
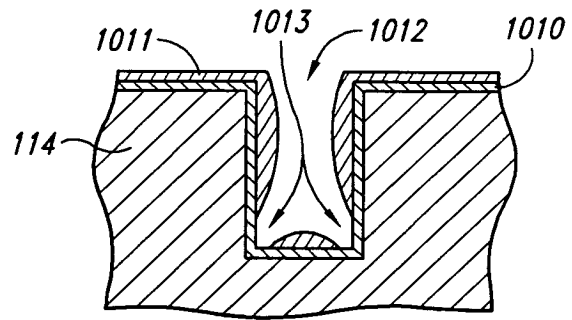
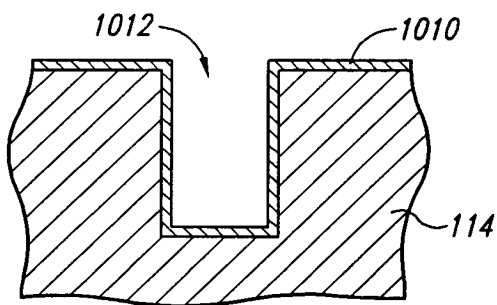
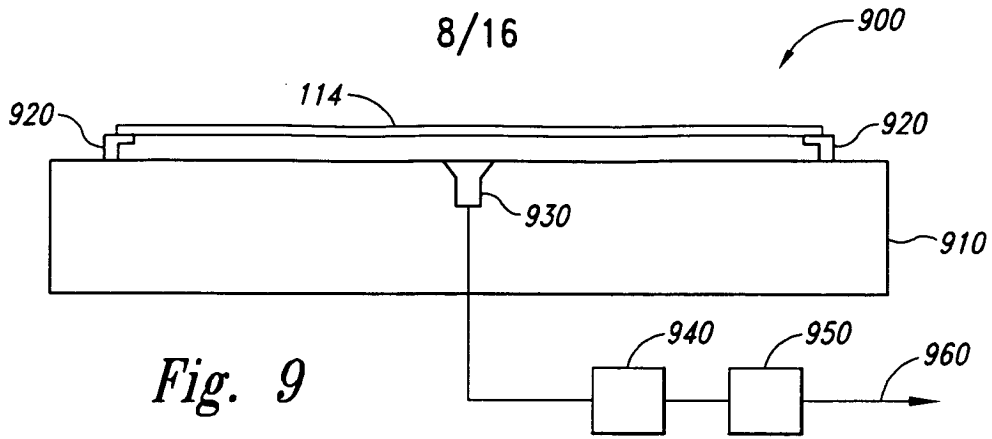
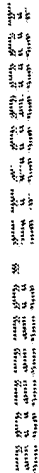


Fig. 5

*Fig. 6*





[illegible]

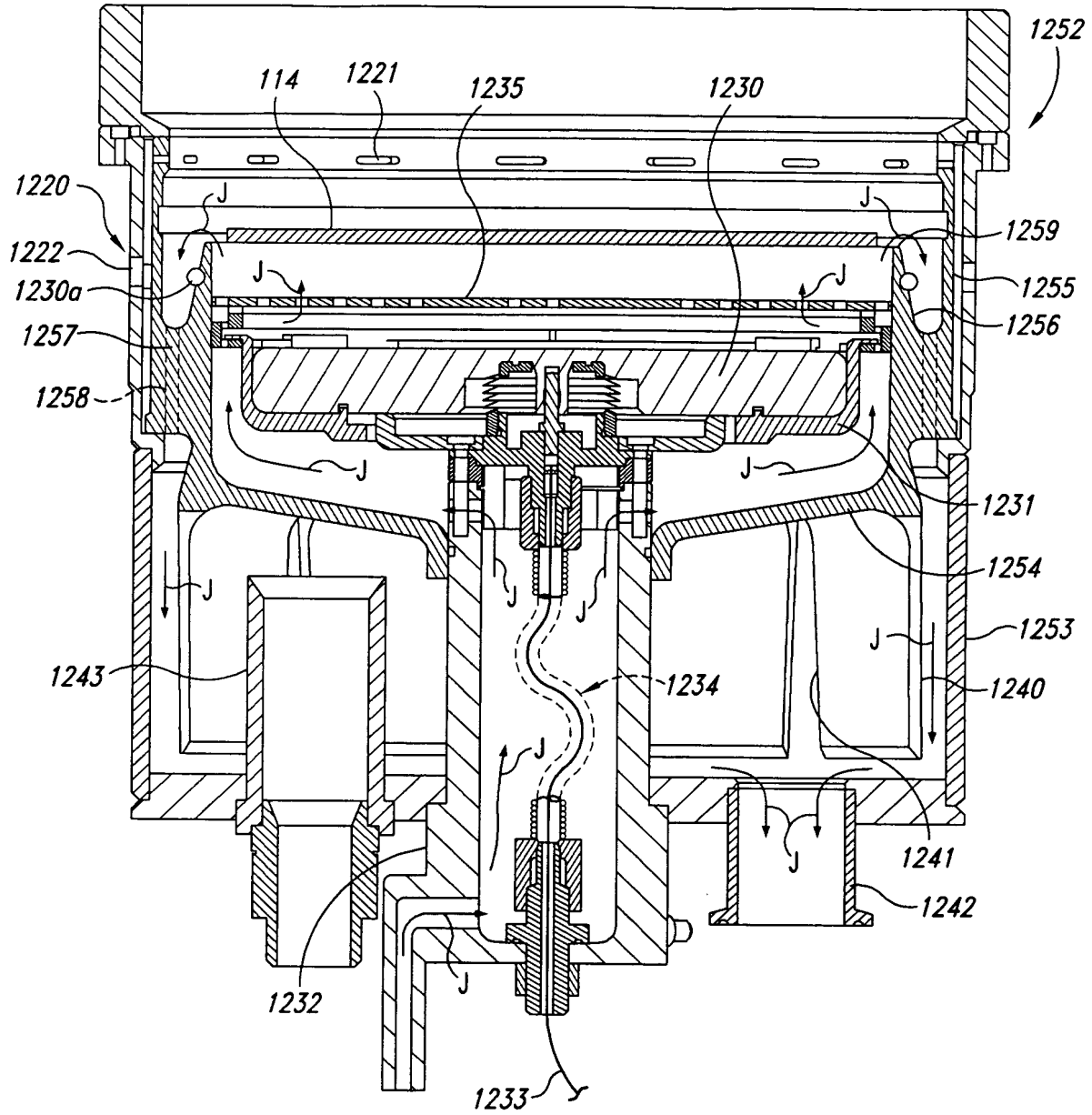


Fig. 12

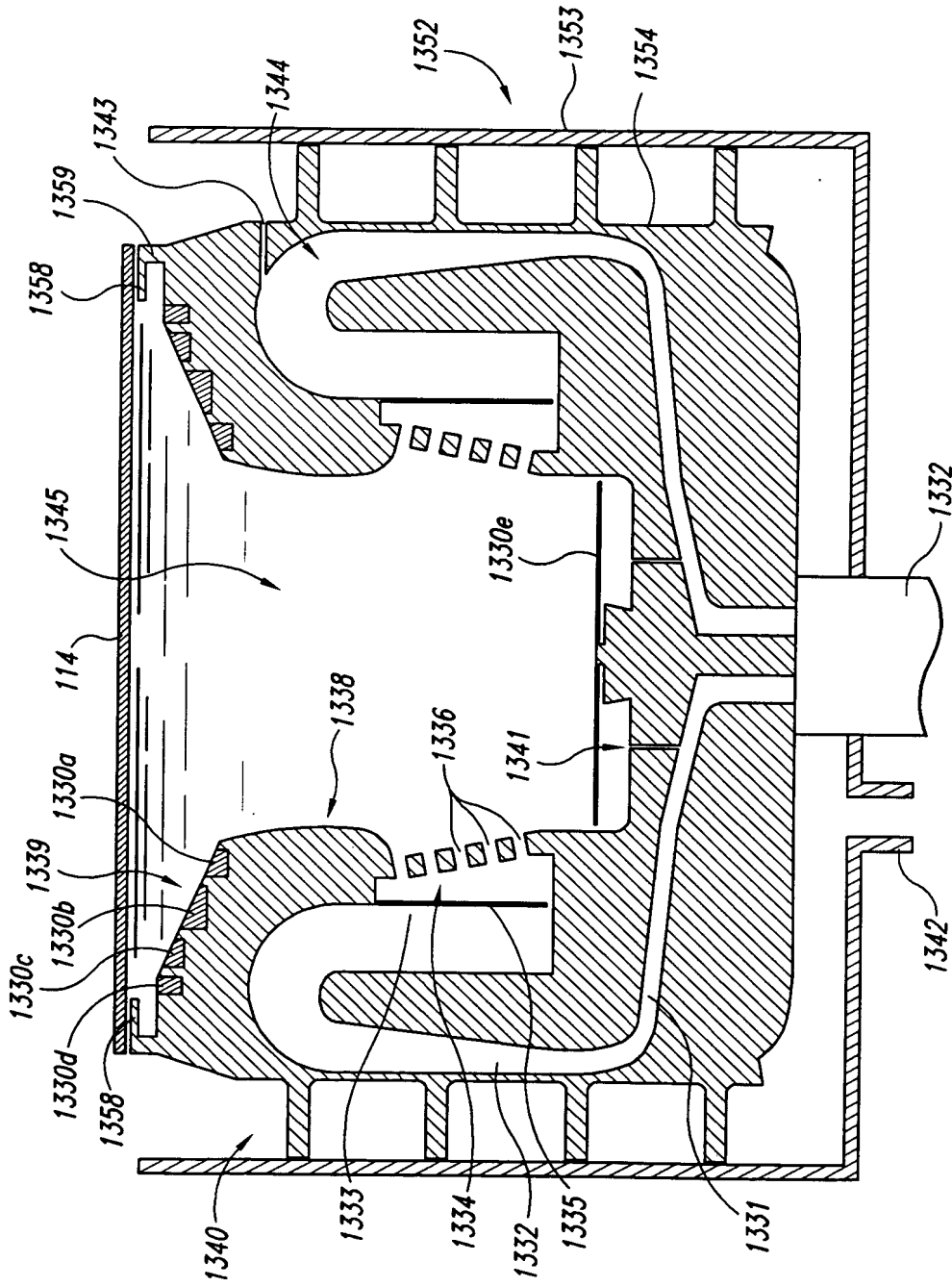


Fig. 13

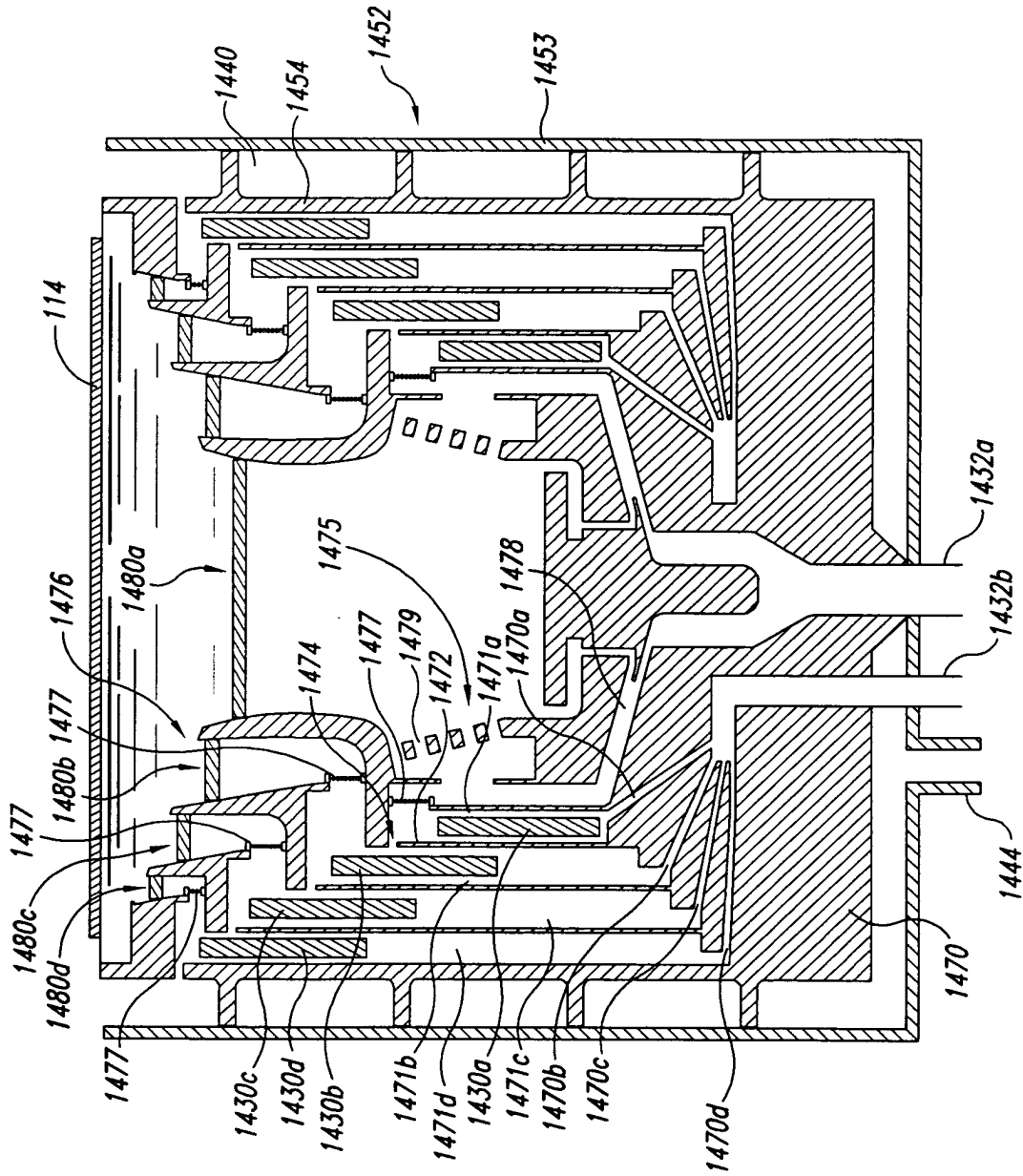


Fig. 14

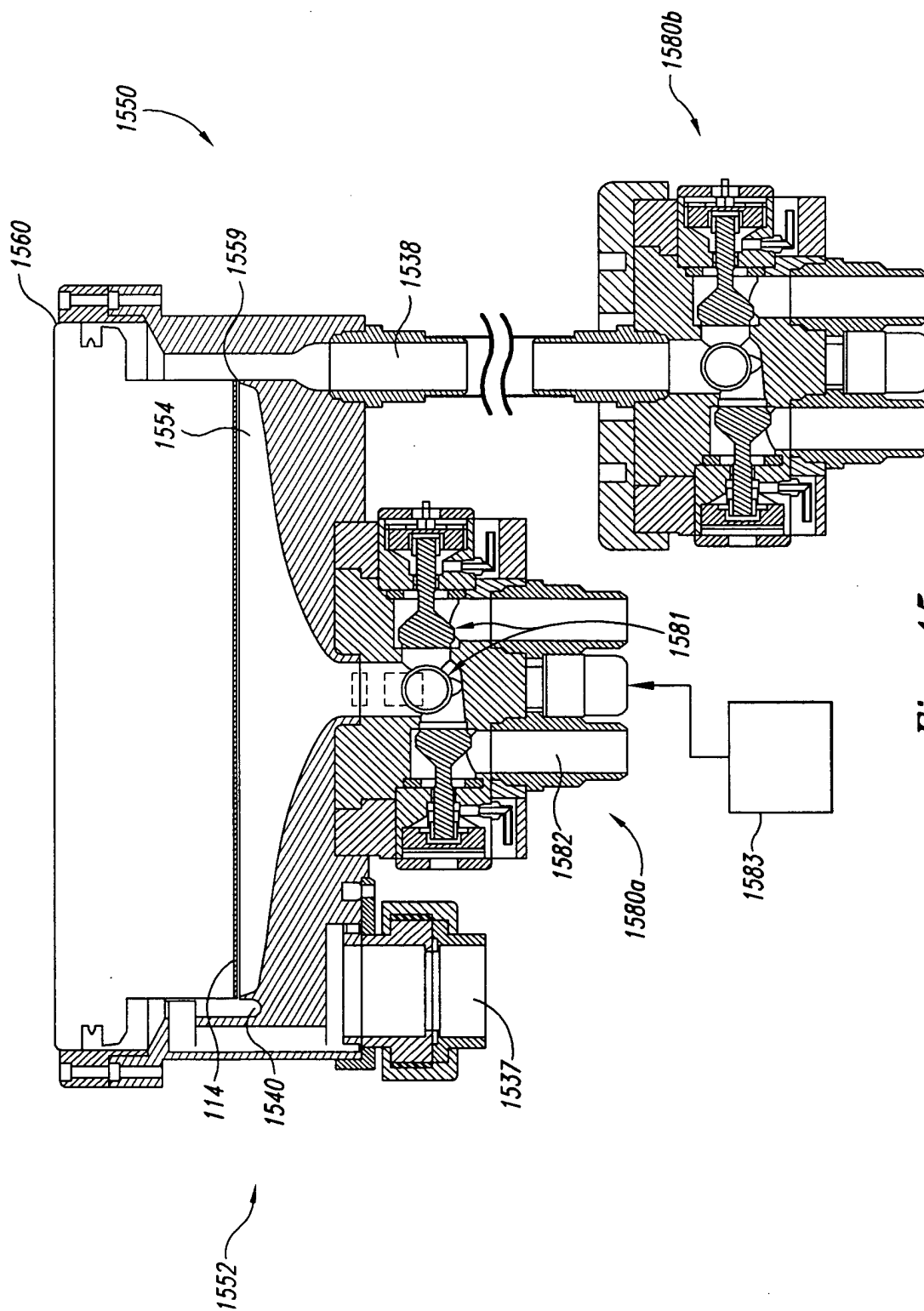


Fig. 15

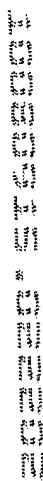
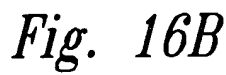


Fig. 16B



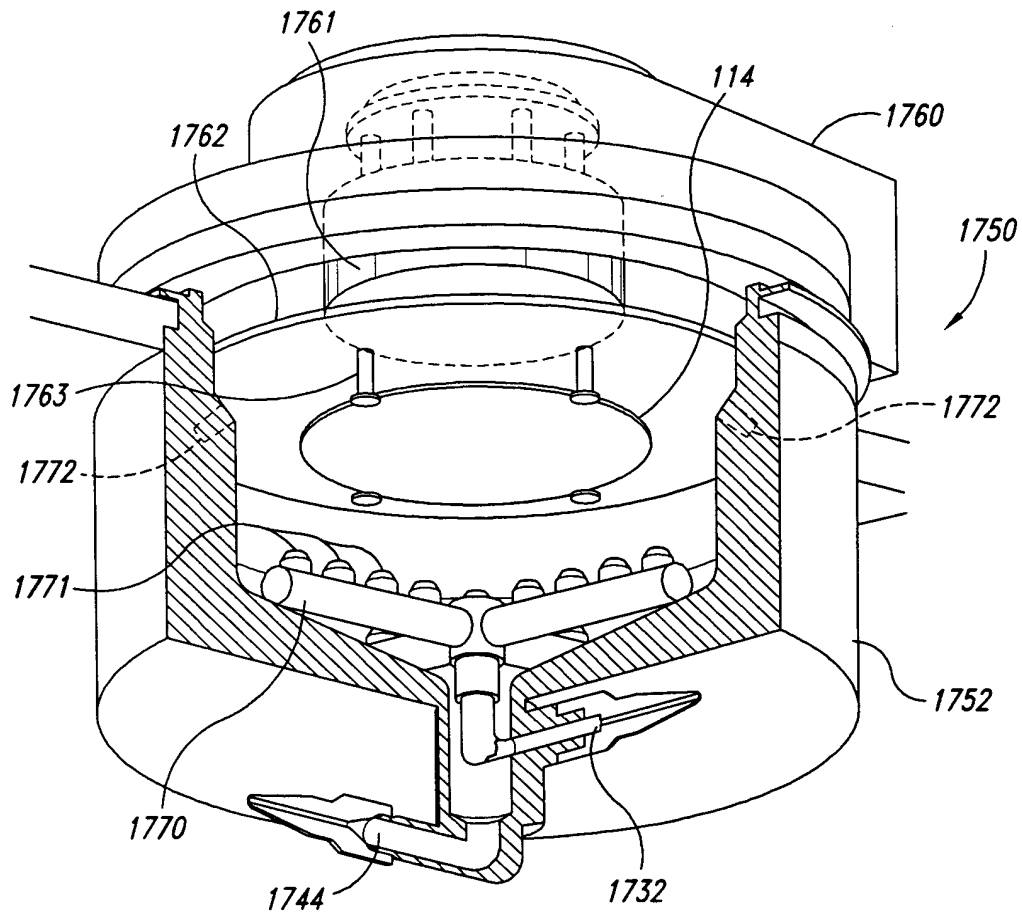


Fig. 17

FIG. 18 is a cross-sectional view of a device 1800, showing a substrate 1802 with a series of openings 1808. The openings are defined by a patterned layer 1810 and a patterned layer 1811. The openings are filled with a material 1812. The device 1800 is shown in a cross-sectional view, with the substrate 1802 and the openings 1808. The openings are defined by a patterned layer 1810 and a patterned layer 1811. The openings are filled with a material 1812.

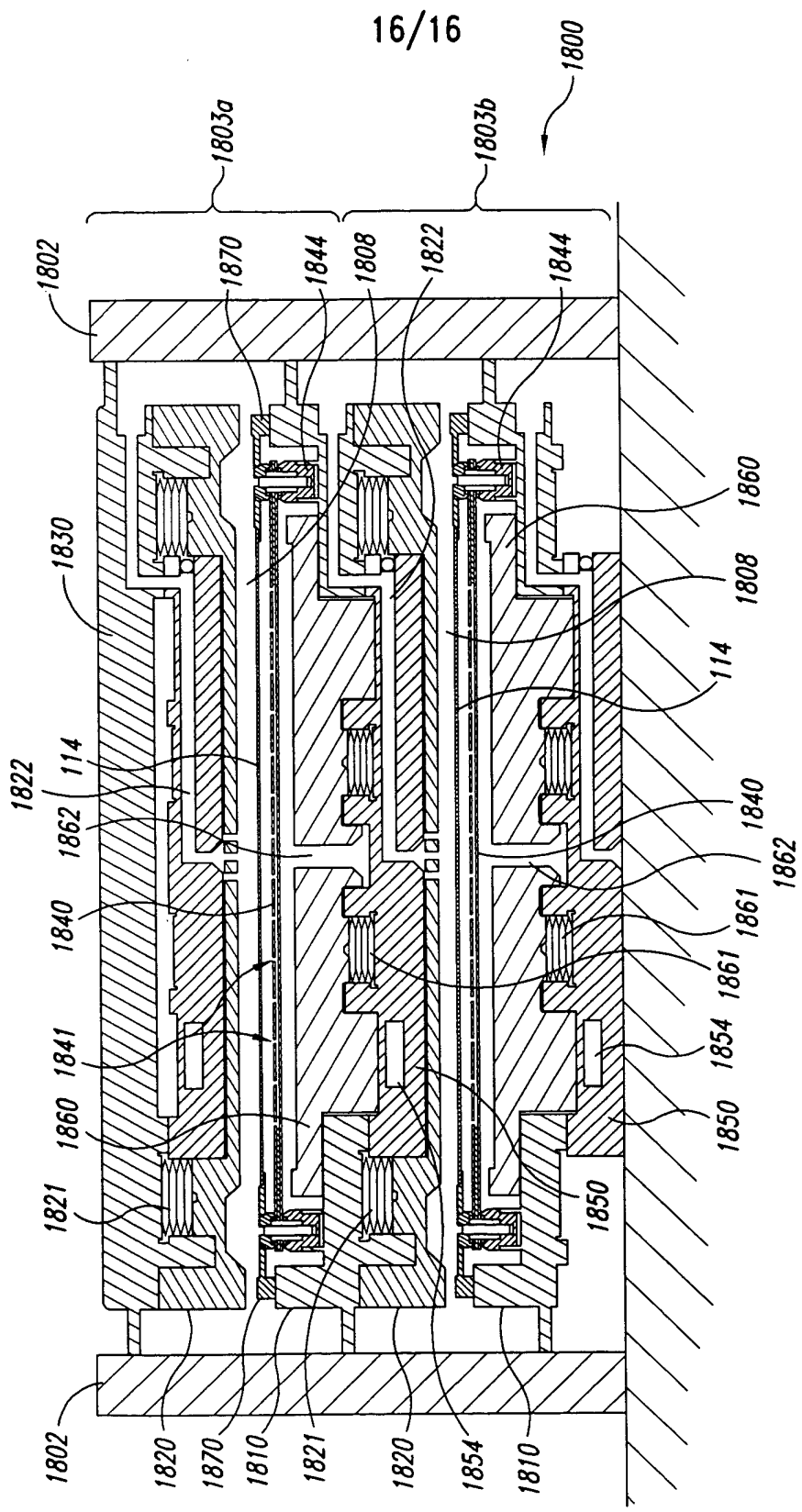


Fig. 18